

THYRISTORS

Silicon thyristors in metal envelopes, intended for general purpose single-phase or three-phase mains operation.

The series consists of reverse polarity types (anode to stud) identified by a suffix R: BTW23-600R to 1600R.

QUICK REFERENCE DATA

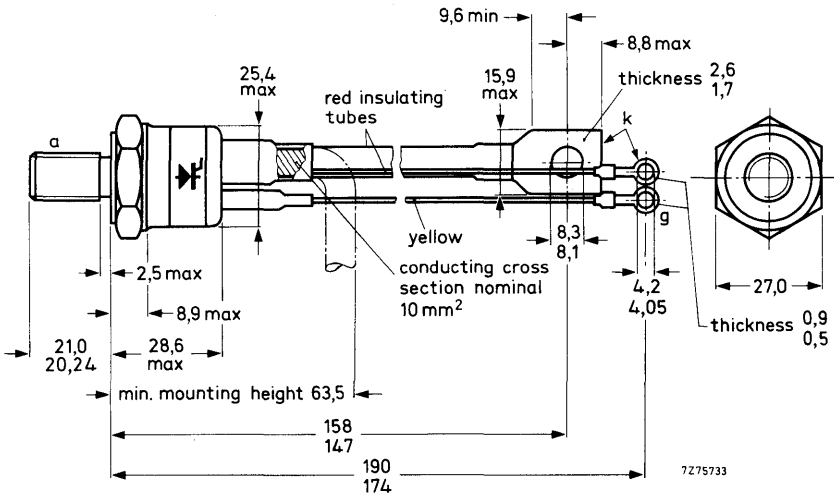
	BTW23-600R	800R	1000R	1200R	1400R	1600R
Repetitive peak voltages $V_{DRM} = V_{RRM}$	max. 600	800	1000	1200	1400	1600 V
Average on-state current				$I_T(AV)$	max. 90 A	
R.M.S. on-state current				$I_T(RMS)$	max. 140 A	
Non-repetitive peak on-state current				I_{TSM}	max. 2000 A	
Rate of rise of off-state voltage that will not trigger any device				dV_D/dt	< 200 V/ μ s	
On request (see ordering note on page 4)				dV_D/dt	< 1000 V/ μ s	

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-94: with metric M12 stud (\varnothing 12 mm); e.g. BTW23-600R.

Types with $\frac{1}{2}$ in x 20 UNF stud (\varnothing 12,7 mm) are available on request. These are indicated by the suffix U: e.g. BTW23-600RU.



Net mass: 134 g
 Diameter of clearance hole: max. 13,0 mm
 Torque on nut: min. 9 Nm (90 kg cm)
 max. 17,5 Nm (175 kg cm)

Supplied with device: 1 nut, 1 lock washer
 Nut dimensions across the flats;
 M12 : 19 mm
 $\frac{1}{2}$ in x 20 UNF: 19 mm

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Anode to cathode

		BTW23-600R	800R	1000R	1200R	1400R	1600R
Non-repetitive peak voltages ($t \leq 10$ ms)	V_{DSM}/V_{RSM}	max. 600	800	1000	1200	1400	1600 V
Repetitive peak voltages	V_{DRM}/V_{RRM}	max. 600	800	1000	1200	1400	1600 V
Crest working voltages	V_{DWM}/V_{RWM}	max. 400	600	700	800	800	800 V*
Average on-state current (averaged over any 20 ms period) up to $T_{mb} = 85$ °C					$I_T(AV)$	max.	90 A
R.M.S. on-state current					$I_T(RMS)$	max.	140 A
Repetitive peak on-state current					I_{TRM}	max.	1250 A
Non-repetitive peak on-state current; $t = 10$ ms; half sine-wave; $T_j = 125$ °C prior to surge; with reapplied V_{RWM} max					I_{TSM}	max.	2000 A
I^2t for fusing ($t = 10$ ms)					I^2t	max.	20 000 A ² s
Rate of rise of on-state current after triggering with $I_G = 750$ mA to $I_T = 300$ A; $dI_G/dt = 1$ A/ μ s					dI_T/dt	max.	300 A/ μ s
Rate of change of commutation current					see Fig. 14		

Gate to cathode

Reverse peak voltage					V_{RGM}	max.	10 V
Average power dissipation (averaged over any 20 ms period)					$P_G(AV)$	max.	2 W
Peak power dissipation					P_{GM}	max.	10 W

Temperatures

Storage temperature		T_{stg}	-55 to + 125 °C
Junction temperature		T_j	max. 125 °C

THERMAL RESISTANCE

From junction to mounting base	$R_{th\ j-mb}$	=	0,3 °C/W
From mounting base to heatsink	$R_{th\ mb-h}$	=	0,1 °C/W
Transient thermal impedance ($t = 1$ ms)	$Z_{th\ j-mb}$	=	0,015 °C/W

* To ensure thermal stability: $R_{th\ j-a} < 0,75$ °C/W (d.c. blocking) or $< 1,5$ °C/W (a.c.). For smaller heatsinks $T_{j\ max}$ should be derated. For a.c. see Fig. 4.

CHARACTERISTICS

Anode to cathode

On-state voltage

$I_T = 500 \text{ A}; T_j = 25 \text{ }^\circ\text{C}$

$V_T < 2,2 \text{ V}^*$

Rate of rise of off-state voltage that will not trigger

any device; exponential method; $V_D = 2/3 V_{DRM \text{ max}};$
 $T_j = 125 \text{ }^\circ\text{C}$

$dV_D/dt < 200 \text{ V}/\mu\text{s}$

Reverse current

$V_R = V_{RWM \text{ max}}; T_j = 125 \text{ }^\circ\text{C}$

$I_R < 15 \text{ mA}$

Off-state current

$V_D = V_{DWM \text{ max}}; T_j = 125 \text{ }^\circ\text{C}$

$I_D < 15 \text{ mA}$

Holding current; $T_j = 25 \text{ }^\circ\text{C}$

$I_H < 200 \text{ mA}$

Gate to cathode

Voltage that will trigger all devices

$V_D = 6 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$

$V_{GT} > 2,5 \text{ V}$

Voltage that will not trigger any device

$V_D = V_{DRM \text{ max}}; T_j = 125 \text{ }^\circ\text{C}$

$V_{GD} < 250 \text{ mV}$

Current that will trigger any device

$V_D = 6 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$

$I_{GT} > 150 \text{ mA}$

Switching characteristics

Gate-controlled turn-on time ($t_{gt} = t_d + t_r$) when
 switched from $V_D = V_{DWM \text{ max}}$ to $I_T = 100 \text{ A};$
 $I_{GT} = 200 \text{ mA}; dI_G/dt = 1 \text{ A}/\mu\text{s}; T_j = 25 \text{ }^\circ\text{C}$

$t_{gt} < 2,5 \mu\text{s}$
 $t_r \text{ typ. } 1 \mu\text{s}$

* Measured under pulse conditions to avoid excessive dissipation.

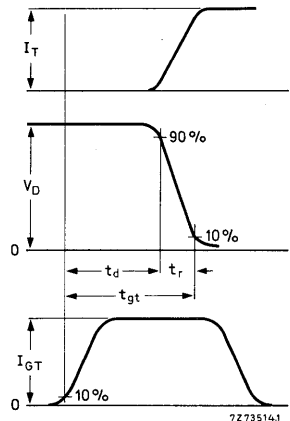


Fig. 2 Gate-controlled turn-on time definitions.

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CHARACTERISTICS (continued)

Circuit-commutated turn-off when switched

from $I_T = 50$ A to $V_R \geq 50$ V with $-dI_T/dt = 50$ A/ μ s;

$dV_D/dt = 200$ V/ μ s;

$T_j = 125$ °C

$T_j = 25$ °C

t_q	typ.	100 μ s
	<	200 μ s
t_q	typ.	60 μ s
	<	120 μ s

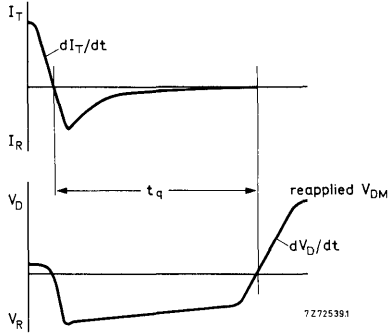


Fig. 3 Circuit-commutated turn-off time definition.

OPERATING NOTE

Switching losses in commutation

For applications in which the thyristor is forced to switch from an on-state current I_{TRM} to a high reverse voltage at a high commutation rate ($-dI_T/dt$), consult Fig. 14 (nomogram) to find the increase in total average power. This increase must be added to the loss from the curves in Fig. 4.

ORDERING NOTE

Types with dV_D/dt of 1000 V/ μ s are available on request. Add suffix C to the type number when ordering; e.g. BTW23-600RC.

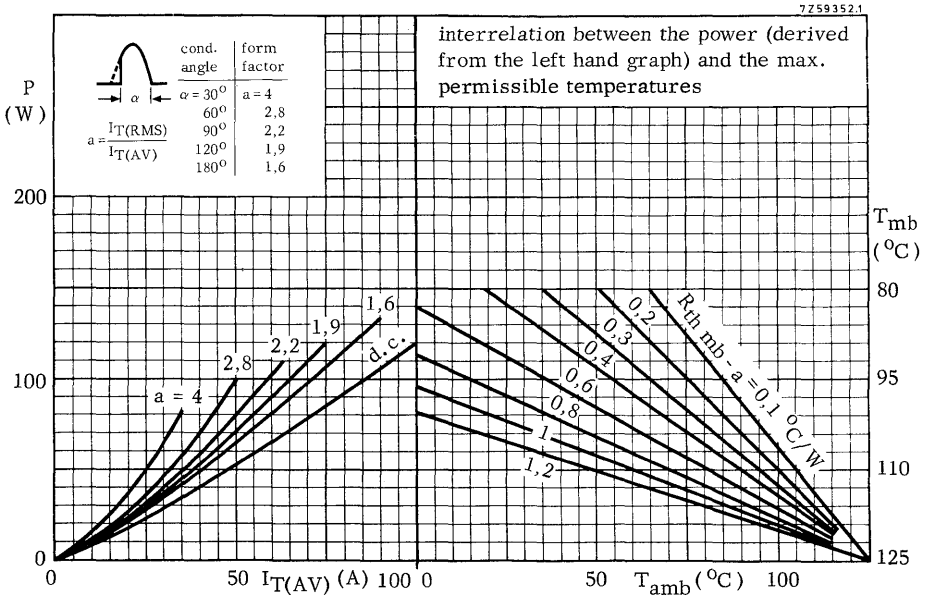


Fig. 4.

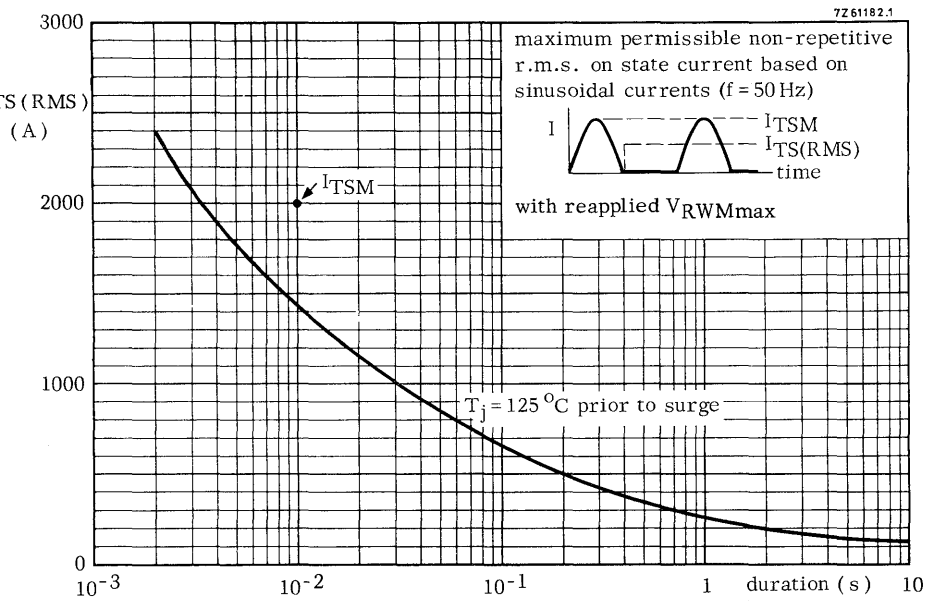


Fig. 5.

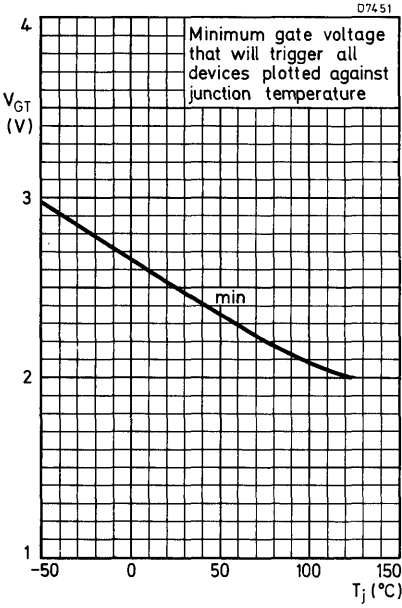


Fig. 6.

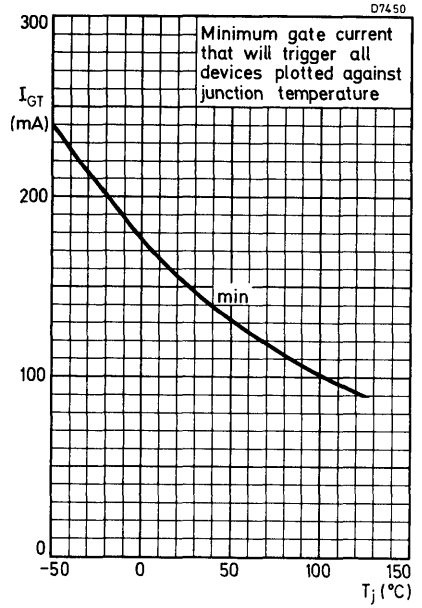


Fig. 7.

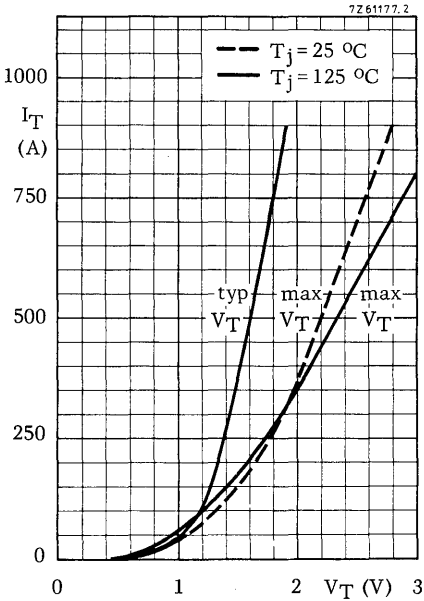


Fig. 8.

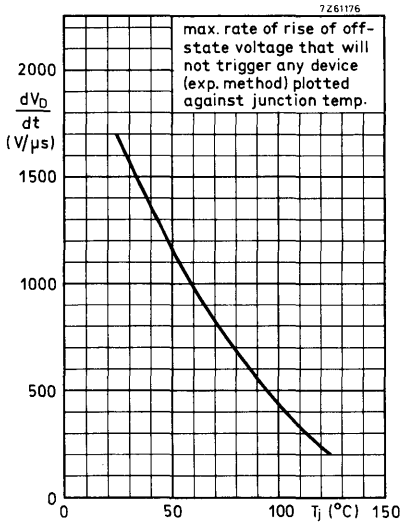


Fig. 9.

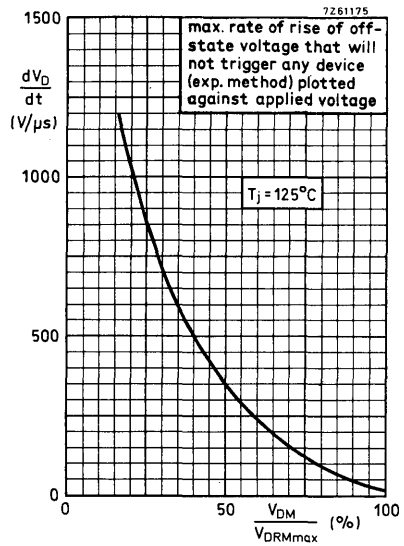


Fig. 10.

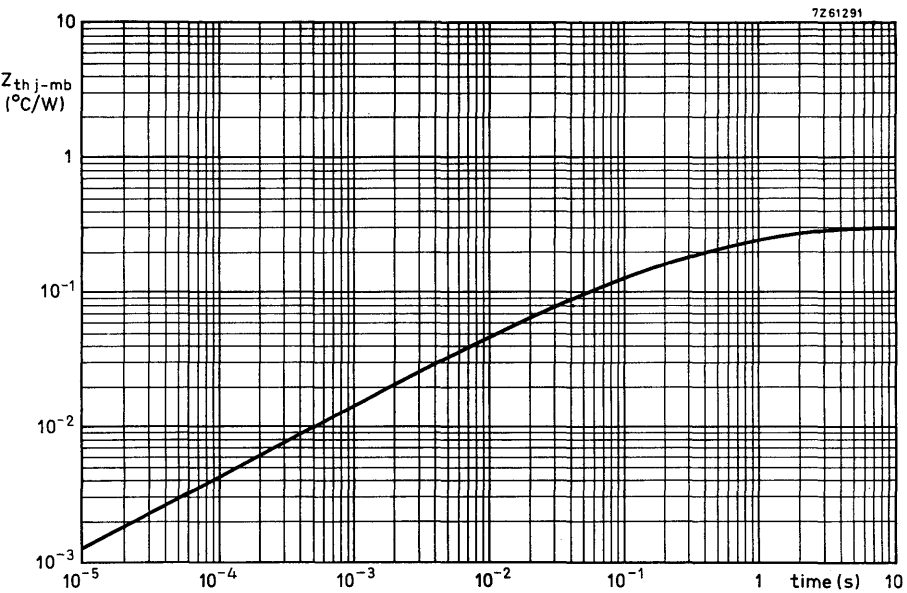


Fig. 11.

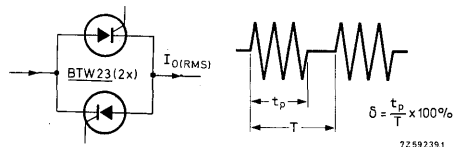
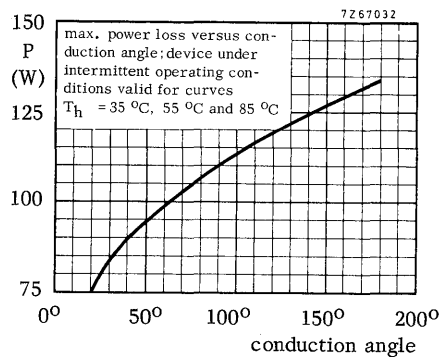
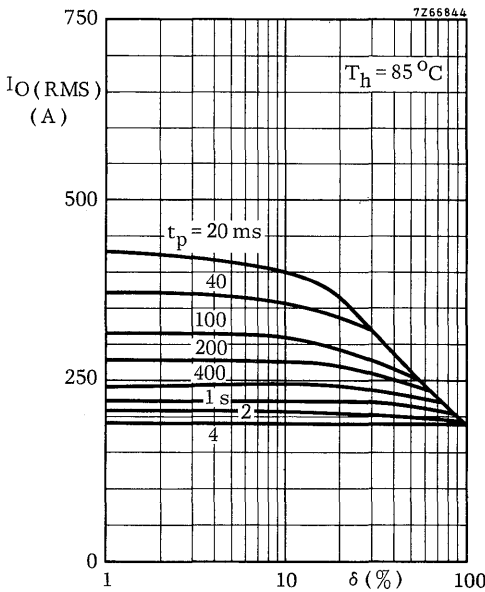
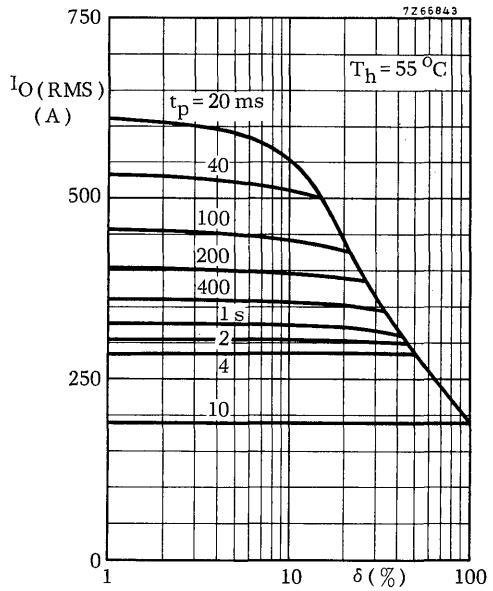
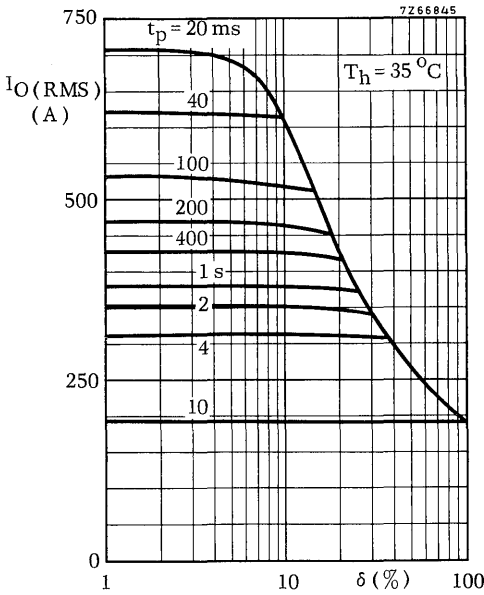


Fig. 12 Intermittent overload capability of two BTW23 thyristors in anti-parallel connection in a single phase a.c. control circuit (e.g. welding); conduction angle 360° .

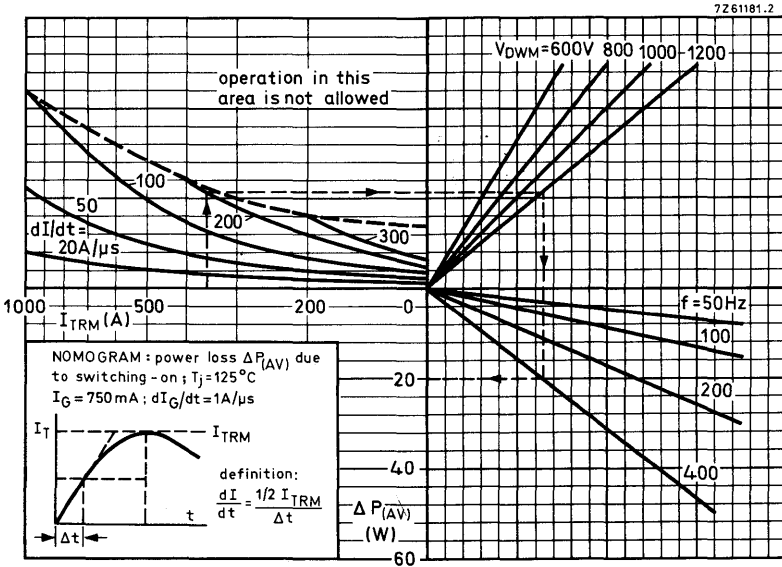


Fig. 13.

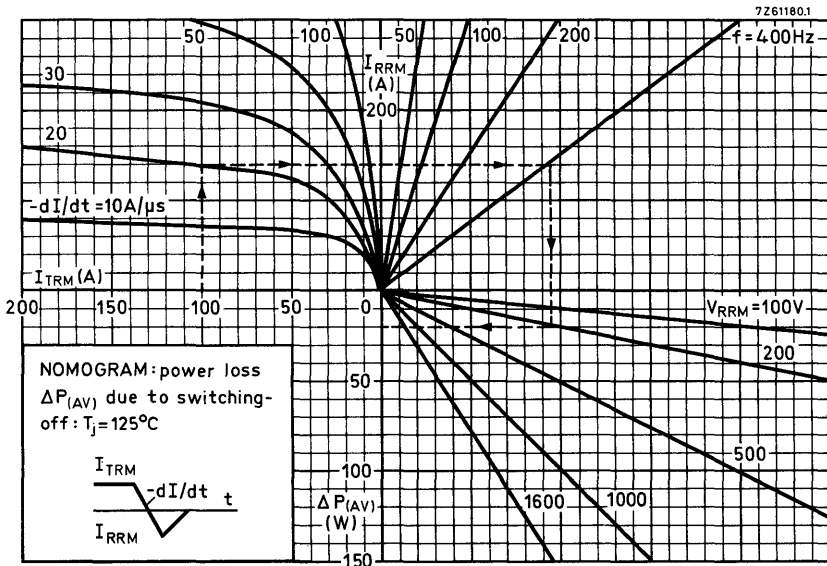


Fig. 14.

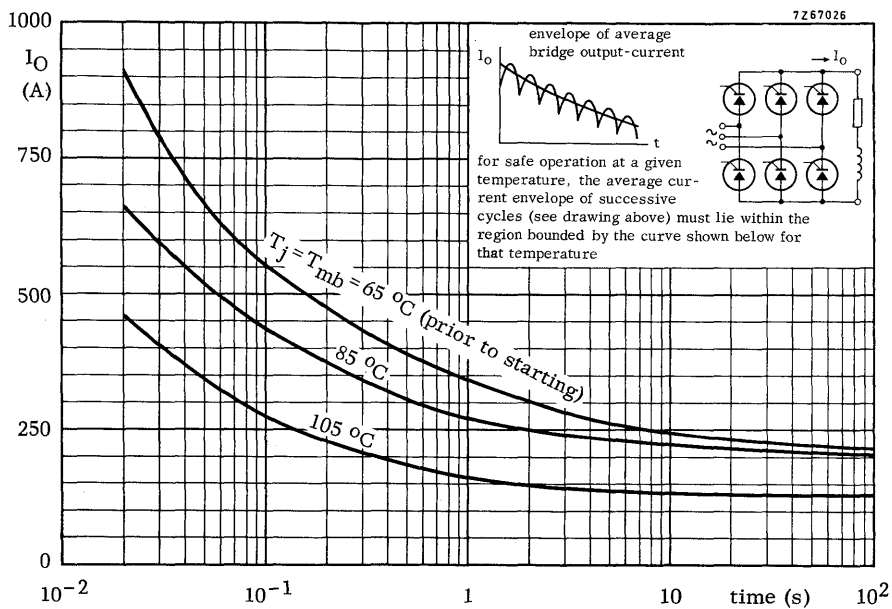
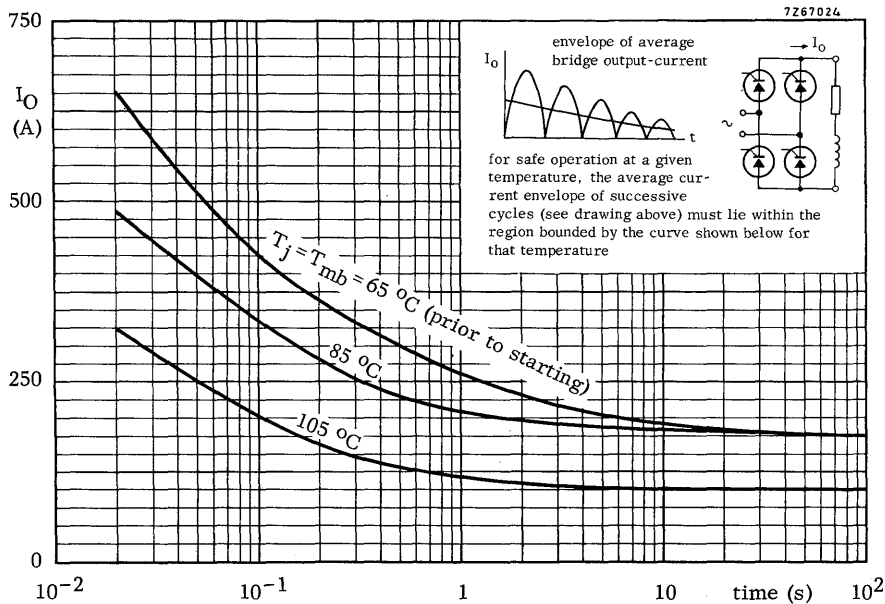


Fig. 15 Limits for starting or inrush currents.